

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Takeshi Uemori	07/07/2011
Ohji Nakagami	07/06/2011
Masahito Yamane	07/08/2011
Yoichi Yagasaki	07/08/2011
RECEIVING PARTY DATA	
Name:	Sony Corporation
Street Address:	1-7-1 Konan, Minato-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	108-0075
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13219849
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ATTORNEY DOCKET NUMBER:	S1459.71071US00
NAME OF SUBMITTER:	Randy J. Pritzker
Total Attachments: 4 source=Executed Assignment 71071#page1.tif source=Executed Assignment 71071#page2.tif source=Executed Assignment 71071#page3.tif source=Executed Assignment 71071#page4.tif	

CH \$40.00 13219849

ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in
IMAGE PROCESSING APPARATUS AND IMAGE PROCESSING METHOD

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, **SONY CORPORATION**, a Japanese corporation, with offices at **1-7-1 Konan, Minato-ku, Tokyo, Japan** (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 13/219,849, Filing Date: Aug. 29, 2011.

This assignment executed on the dates indicated below.

TAKESHI UEMORI

Name of first or sole inventor
TOKYO JAPAN

Residence of First or sole inventor

Takeshi Uemori
Signature of first or sole inventor

Execution date of U.S. Patent Application

July 7, 2011
Date of this assignment

OHIJI NAKAGAMI

Name of second inventor
TOKYO JAPAN

Residence of second inventor

Signature of second inventor

Execution date of U.S. Patent Application

Date of this assignment

MASAHITO YAMANE

Name of third inventor
KANAGAWA JAPAN

Residence of third inventor

Masahito Yamane
Signature of third inventor

Execution date of U.S. Patent Application

July 8, 2011
Date of this assignment

ADDITIONAL INVENTOR(S)

YOICHI YAGASAKI

Name of fourth inventor
TOKYO JAPAN

Residence of fourth inventor

Yoichi Yagasaki
Signature of fourth inventor

Execution date of U.S. Patent Application

July 8, 2011
Date of this assignment

Name of fifth inventor

Residence of fifth inventor

Signature of fifth inventor

Execution date of U.S. Patent Application

Date of this assignment

Name of sixth inventor

Residence of sixth inventor

Signature of sixth inventor

Execution date of U.S. Patent Application

Date of this assignment

Name of seventh inventor

Residence of seventh inventor

Signature of seventh inventor

Execution date of U.S. Patent Application

Date of this assignment

Name of eighth inventor

Residence of eighth inventor

Signature of eighth inventor

Execution date of U.S. Patent Application

Date of this assignment

Name of ninth inventor

Residence of ninth inventor

Signature of ninth inventor

Execution date of U.S. Patent Application

Date of this assignment

ASSIGNMENT

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NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

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And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 131219,849, Filing Date: Aug. 29, 2011.

This assignment executed on the dates indicated below.

TAKESHI UEMORI
Name of first or sole inventor
TOKYO JAPAN
Residence of First or sole inventor

Execution date of U.S. Patent Application

Signature of first or sole inventor

Date of this assignment

OHJI NAKAGAMI
Name of second inventor
TOKYO JAPAN
Residence of second inventor

Execution date of U.S. Patent Application

Ohji Nakagami
Signature of second inventor

July 6, 2011
Date of this assignment

MASAHITO YAMANE
Name of third inventor
KANAGAWA JAPAN
Residence of third inventor

Execution date of U.S. Patent Application

Signature of third inventor

Date of this assignment

ADDITIONAL INVENTOR(S)

YOICHI YAGASAKI Name of fourth inventor TOKYO JAPAN Residence of fourth inventor	Execution date of U.S. Patent Application
Signature of fourth inventor	Date of this assignment
Name of fifth inventor Residence of fifth inventor	Execution date of U.S. Patent Application
Signature of fifth inventor	Date of this assignment
Name of sixth inventor Residence of sixth inventor	Execution date of U.S. Patent Application
Signature of sixth inventor	Date of this assignment
Name of seventh inventor Residence of seventh inventor	Execution date of U.S. Patent Application
Signature of seventh inventor	Date of this assignment
Name of eighth inventor Residence of eighth inventor	Execution date of U.S. Patent Application
Signature of eighth inventor	Date of this assignment
Name of ninth inventor Residence of ninth inventor	Execution date of U.S. Patent Application
Signature of ninth inventor	Date of this assignment